KEMAPOX GRUND 2040

Epoxy coating for substrates with moisture up to 5%

- High penetration into the substrate
- Universal application
- Low viscosity
- Easy to use
- For outdoor and indoor use



KEMA

PRODUCT DESCRIPTION	2-component impregnating epoxy coating and bond old-new.
FIELD OF USE	For priming of commonly cement based surfaces, for filling of capillaries and pores, for reinforcement and thin-layer levelling. It is of low viscosity, suitable for filling with quartz sand and for thin epoxy screeds and mortars. For outdoor and indoor use.
	 Primer on concrete, cement screeds, epoxy leveling and mortars. Primer in the installation of all Kema epoxy and polyurethane floors. For reinforcement and as an anti-dust coating for cement based substrates. Suitable for use on normal to strongly absorbent cement substrates. Suitable for filling with quartz sand of different grain sizes, to implement thin epoxy leveling and epoxy mortar.
PRODUCT PROPERTIES	 High penetration into the substrate Universal application Low viscosity Easy to use

• For outdoor and indoor use



PRODUCT DATA		
BASIC	A	Component A: colourless fluid; Component B: brownish fluid
INFORMATION	Appearance	Component A. Colourtess Itula, Component B. Brownish Itula
	Packing	32 kg (20 kg of component A and 12 kg of component B)
		Bulk cargo: 200 kg of component A and 200 kg of component B
	Storage and expiration date	At an appropriate storage (dry, in the temperature range between +5 $^\circ$ C to +
		30 ° C in original and undamaged packaging), 12 months from date of
		manufacture. Protect the product from freezing, direct sun and heat sources.
TECHNICAL DATA	Chemical composition	Modified epoxy resin and modified cycloaliphatic
		hardener
		11-/3
	Density of component A (25°C)	1,1 g/cm ³
	Density of component B (25°C)	0,955 g/cm ³
	Density of mixture (25°C)	1,00 g/cm ³
	Viscosity of component A (25°C)	950-1250 mPa.s
	Viscosity of component B (25°C)	10-30 mPa.s
	Viscosity of mixture (25°C)	400 mPa.s
	Dry matter content	Approx.: 99 %
	Bond strength	> 1,5 N/mm ²
Compressive strength	of mortar (KG 2040:ES 0,1-0,3=1:10	> 45 N/mm ²
Flexural strength	of mortar (KG 2040:ES 0,1-0,3=1:10	> 20 N/mm ²
	Shore D after 24 hours	55
	Shore D after 48 hours	65
	Shore D after 3 days	72
	Shore D after 7 days	72

THERMAL	Exposure	Dry heat
RESISTANCE	long- term	+50°C
	short- term, up to 7 days:	+80°C
	short- term, up to 12 hours	+100°C

Exposure should not be simultaneous chemical and mechanical.



INSTRUCTIONS FOR USE IMPLEMENTATION 1. Primer prior to installation of epoxy floor, substrate reinforcement, anti- dust coat: Normally absorbent substrate 1 layer KEMAPOX GRUND 2040 Strongly absorbent substrate 2 layers KEMAPOX GRUND 2040 2. Epoxy leveling compound (leveling up to 2 mm): Normally absorbent 1 layer KEMAPOX GRUND 2040 and 1 layer KEMAPOX GRUND 2040 + EPOXY substrate SAND ES 0,1 - 0,3 Strongly absorbent 2 layers KEMAPOX GRUND 2040 and 1 layer KEMAPOX GRUND 2040 + EPOXY substrate SAND ES 0,1 - 0,3 3. Epoxy mortar (15 to 20 mm) Normally absorbent 1 layer KEMAPOX GRUND 2040 as bonding layer and 1 layer KEMAPOX GRUND 2040 + substrate: **EPOXY SAND ES 80** Strongly absorbent 1 layer KEMAPOX GRUND 2040 and 1 layer KEMAPOX GRUND 2040 as bonding layer substrate and 1 layer KEMAGRUND 2040 + EPOXY SAND ES 80 CONSUMPTION 1. Primer prior to installation of epoxy floor, substrate reinforcement, anti- dust protection coating, bonding layer: 0,3 - 0,5 kg/m2 for one layer, depending on the absorbency of the substrate. 2. Epoxy leveling compound (leveling up to 2 mm): 1,4 to 1,6 kg/m2 for 1 mm thickness (mixing ratio resin: sand = 1:1) 3. Epoxy mortar (15 to 20 mm): 2,2 kg/m2 for 1 mm thickness (mixing ratio resin: sand = 1:10) BASE The substrate must be clean, dry, stable, sound and free from cement crust, dust, oil, grease, loose particles and similar impurities. Compressive strength of the substrate must be at least 25 MPa, the average bond strength of at least 1.5 MPa (the smallest measured value shall not be less than 1.0 MPa). Moisture content in substrate must be not more than 5%, measured by the CM method (concrete at least 35 MB).

TECHNICAL DATA SHEET



BASE PREPARATION	Prepare by appropriate mechanical methods such as grinding, milling, ball or sand blasting or burning to remove the top layer of the surface and to achieve an open texture of the surface. Unbound and loose particles must be removed, it is also necessary to fully repair all defects such as holes, dents or cracks, and irregularities and voids. Defects, cracks and holes must be repaired with appropriate KEMA products (eg. KEMAPOX FILL, KEMAPOX GRUND,). Before application of the resin completely remove dust and loose particles from the substrate, using a broom or vacuum cleaner
MIX RATIO	A:B=100:60 (ratio of components A and B); Dry quartz sand is added according the purpose of use
MIX TIME	Epoxy resin is usually thicker than the hardener, so that they can not be easily stirred. Before mixing component A with component B, stir the two components individually. The recommended time for mixing the individual components is 2-3 minutes, then all of part B is mixed into all of part A. With a mixer intensively stir the mixture into a homogenous compound. It is important that the compound is intensely stirred that the hardener is evenly distributed in the compound. It is necessary to mix on the sides and from the bottom upwards, so that the hardener evenly distributes in the vertical direction, until the compound is completely homogeneous and of uniform color. Mixing time should be at least 3 minutes. Recommended temperature when mixing must be greater than 15 ° C. Before use, the mixed components must be poured over in a new, clean container and again well stirred. The second mixing should not take too long to avoid the entry of too much air in the compound.This containr must be clean and free of grease, oil or other impurities. If you are preparing a small quantity of epoxy coating, use a third clean container. First mix the two components individually, then pour in a third container the exact quantity of component A and then of component B.The mixing procedure should be the same as described above. Use weighing scales with an accuracy of + / -0,01 kg. If you add a third component of dry quartz sand, first mix the two components. Then gradually add the sand in steps of 15%. The total quantity of added sand depends on the purpose of installation and must be determined in each case.
MIX TOOL	Component B must be added to component A and stirred thoroughly, preferably with a spiral mixing spindle

MIX TOOL Component B must be added to component A and stirred thoroughly, preferably with a spiral mixing spindle attached to a drill with max. 300-400 rpm .



INSTALLATION	Before application, check the moisture, relative humidity and dew point. If all conditions are met the installation can begin.				
	1. Primer prior t	o installation of epoxy	floor, substrate re	inforcement, anti-	dust protection coating, bonding layer:
	Pour mixed mat	erial (follow instruction	ns) over the surfac	e, use spatula fron	n hard gum, roller or trowel and
	distribute evenl	y. After about 5 minute	s evenly distribute	it using a paint ro	ller in cross pulls. In the case of highly
	absorbent subs	trate apply the second o	coat after approx.	10-12 hours (depe	nding on temperature).
	2. Epoxy levelin	g compound (leveling ι	ıp to 2 mm):		
	Prepare your m	aterial according to ins	tructions and pour	over the surface.	Use a spatula from hard gum or masonry
	trowel to distrib	oute resin to the desired	l thickness. Depen	ding on project the	e fresh resin can also be strewn with dry
	sand.				
	3. Epoxy mortar	r (15 to 20 mm):			
	Epoxy mortar sł	nall be prepared accord	ling to instructions	and installed on t	he fresh bonding layer. Using a spatula
	from hard gum	or masonry trowel to di	stribute the resin	to the desired thic	kness, you can also use a leveling board.
	If you want to le	evel the surface of the e	poxy mortar use o	ompound KEMAP	OX GRUND 2040 and KEMAPOX DENS
	SM, which is ap	plied onto the still wet o	epoxy mortar.		
TOOL	KEMAPOX Grun	d 2040 is applied to the	e prepared surface	with a paint rolle	r, a metal trowel or notched trowel.
CLEANING OF	Clean tools imn	nediately after use with	diluent KEMAPO	CLEANER. Harder	ned material can be removed from the
TOOL	tool only mecha	anically.			
OPEN TIME	30 minutes (at +	-25°C, 100 g)			
COAGULATION	Processing time	9			
	Temperature	Ready for foot traffic	Lighter loading	Full loading	
	+10°C	approx. 24 hours	approx. 5 days	approx. 10 days	

approx. 3 days

approx. 2 days

Waiting time between coats:

+20°C

+30°C

Substrate temperature	Minimum	Maximum
+10°C	24 - 26 hours	4 - days
+20°C	12 - 24 hours	2 - 4 days
+30°C	6 - 12 hours	1 - 2 days

approx. 12 hours

approx. 6 hours

Times are approximate and depend on the ambient conditions, particularly on temperature and relative humidity.

approx. 7 days

approx. 5 days



LIMITATIONS	
BASE TEMPERATURE	+10°C min. / +30°C max.
AIR TEMPERATURE	+10°C min. / +30°C max.
MATERIAL TEMPERATURE	+15°C min.
WARNINGS	 Protect freshly installed material from freezing, rain and other weather conditions. The material should not be used at temperatures below +10 ° C. It is recommended that the material is used at a maximum humidity of 80%. The maximum permissible moisture is 5% for concretes of label C30/37 (determined by CM-apparatus or laboratory drying). It is recommended that the material is stored in a dry place, protected from direct sunlight and frost. Protect freshly installed epoxy resin from moisture, condensation and water for at least 24 hours from installation. In outdoor use, install the resin when the temperature decreases. In the case of rising temperature, holes on the surface may occur. If heating is required do not use gas, oil, paraffin or other fossil fuels for heating. It is recommended to use an electrical method of heating, because organic fuels release CO2 and H2O, which may adversely affect the surface appearance. Dew Point:The substrate and unhardened resin must be at least 3°C below the dew point to reduce the risk of condensation or blooming on the floor finish. The epoxy resin is composed of two components, so take into consideration the given mixing ratio. Uninterrupted access to closed site, 3 phase current, strength of at least 32 A, lighting of surfaces, where the floor will be implemented, protection against rain and direct sunlight.
	legislation. Data source: All technical data in this technical sheet was obtained by laboratory research. Actual data may differ due to different working conditions on which we have no influence.
	Local restrictions: Due to specific local regulations the installed product can differ from country to country. For

exact instructions for use, demand a country specific technical data sheet.

SAFETY DATA

At work we have to use gloves and protective skin cream. Hardener should not come into contact with skin and especially not in eyes. Stains on the skin are washed with soap and water, but if accidentally splashed into the eyes, they should immediately be washed with plenty of water and seek medical advice.

Further information on storage, handling and use of compound are contained in this safety data sheet which contains safety, toxicological and ecological data, we must also pay attention to warnings on the original packaging.



LEGAL BASE

Information and recommendations relating application and end use of Kema products, are given in good faith based on our temporary knowledge and experience of the products, if they are properly stored, properly handled and used under normal conditions. In practice, the differences in materials, substrates and actual site conditions are such that from this information or any written recommendations, or from any other advice no tradability or suitability for a particular purpose, nor any liability arising from any legal relationship can be guaranteed.. Proprietary rights of third must be respected. All orders fall under current sales and supply conditions. Customers should always refer to the latest technical data sheet for the concerned product, copies of the technical data sheet are available on request.

